

NOTES:  
 1. MIN. PUSHOUT FORCE: .5 lb.  
 2. PLANARITY TO BE WITHIN .006 [.15].  
 3. Ⓢ REPRESENTS A CRITICAL DIMENSION FOR STATISTICAL PROCESS CONTROL.

UNLESS OTHERWISE NOTED TOLERANCES ARE:  
 DIMENSIONS ARE IN INCHES  
 ONE PLACE DECIMALS ± .1 THREE PLACE DECIMALS ± .005  
 TWO PLACE DECIMALS ± .01 FOUR PLACE DECIMALS ± .0020  
 ANGLES ± 2°

TITLE: STAMPED & FORMED DIP ASM.  
 DWG NO: ICF-XXX-XXX-X-XX  
 SHEET 1 OF 1

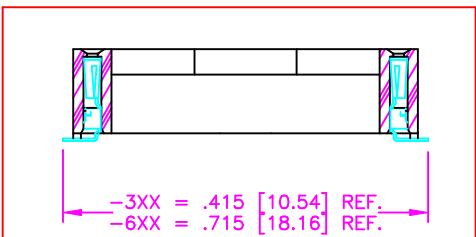
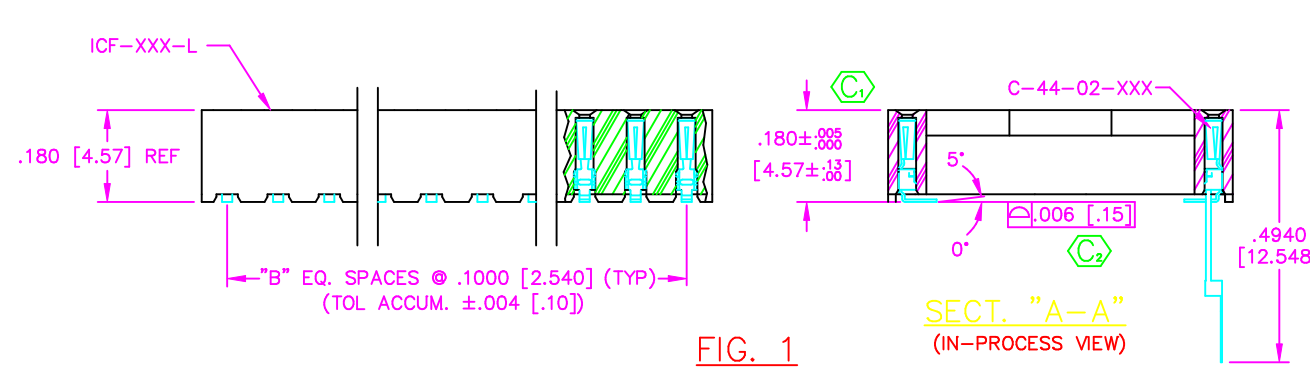
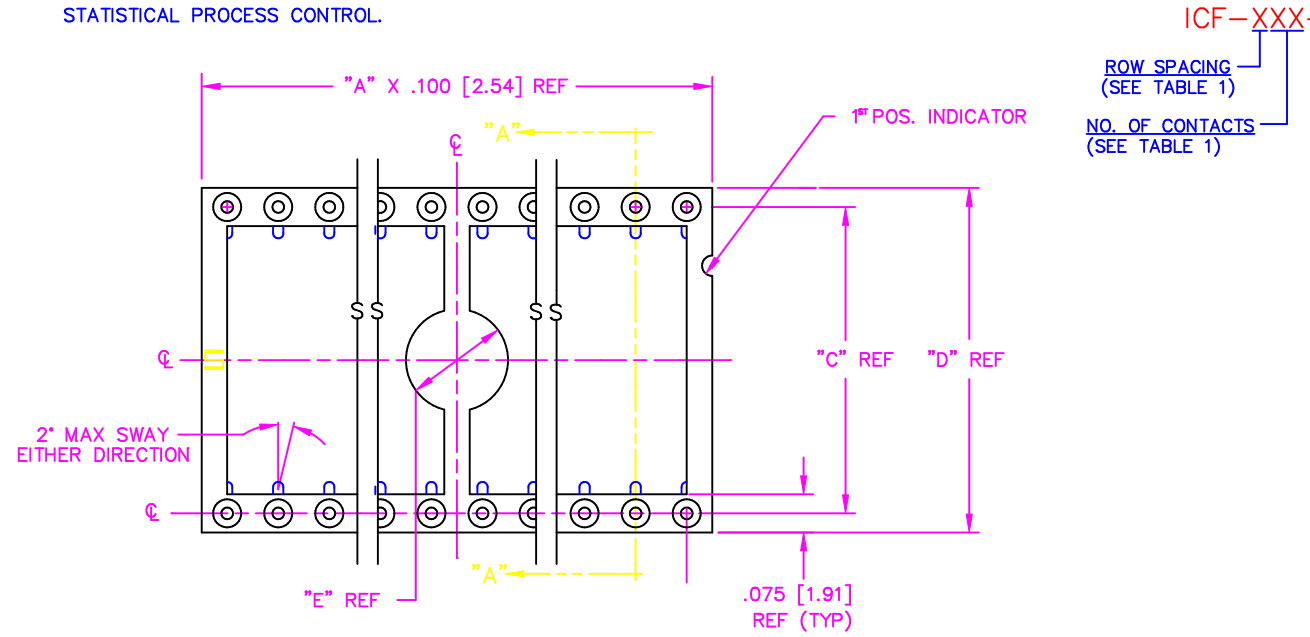


FIG. 2  
 LEAD STYLE 0  
 SAME AS FIG 1 EXCEPT AS SHOWN

- ICF-XXX-XXX-X-XX
- ROW SPACING (SEE TABLE 1)
  - NO. OF CONTACTS (SEE TABLE 1)
  - PACKAGING OPTION
    - TR: TAPE & REEL (FIG 5)
    - LEAVE BLANK FOR TUBE (FIG 4)
  - LEAD STYLES
    - I: TAILS IN - SEE FIG. 1
    - O: TAILS OUT - SEE FIG. 2
  - PLATING SPECIFICATION
    - S: SELECTIVE (USE C-44-02-S)
    - T: TIN (USE C-44-02-T)
    - F: FLASH SELECTIVE GOLD (USE C-44-02-F)
    - TL: TIN/LEAD (USE C-44-02-TL)
    - STL: SELECTIVE TIN/LEAD (USE C-44-02-STL)
    - TM: MATTE TIN (USE C-44-02-T)
    - FM: FLASH GOLD SELECTIVE, MATTE TIN TAIL (USE C-44-02-F)
    - SM: HEAVY GOLD SELECTIVE, MATTE TIN TAIL (USE C-44-02-S)

PACKAGE PARTS IN TUBE AS SHOWN (FIG 4)

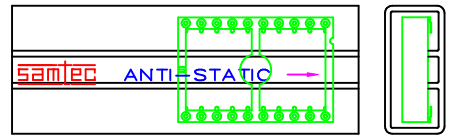
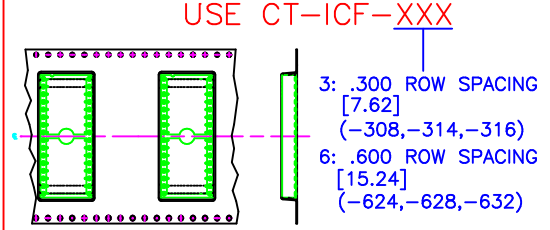


TABLE 2

SERIES	LEAD STYLE	PACKAGING TUBE	PLUG
.300 [7.62]	I	PT-1-24-01-25	TP-03
.600 [15.24]	I	PT-1-24-02-25	TP-03
.300 [7.62]	0	PT-1-24-03-25	TP-03
.600 [15.24]	0	PT-1-24-04-25	TP-03

PACKAGE PARTS IN TAPE & REEL AS SHOWN (FIG 5)



SURFACE MOUNT LEADS TO BE FACE DOWN IN THE POCKET

PLOT SCALE: 1=2

**samtec** EXISPROD\ASSEMBLY\DIP ICF-ASM

520 PARK EAST BLVD. NEW ALBANY, INDIANA 47150  
 PHONE (812) 944-6733 P.O. BOX 1147  
 CODE 55322

TABLE 1

"X"	"XX"	"A"	"B"	"C"	"D"	"E"
3	08	4	3	.3000 [7.620]	.375 [9.53]	.200 [5.08]
	14	7	6			
	16	8	7			
	18	9	8			
	20	10	9			
	22	11	10			
	24	12	11			
6	28	14	13	.6000 [15.240]	.675 [17.15]	.400 [10.16]
	24	12	11			
	28	14	13			
	32	16	15			
	40	20	19			
	48	24	23			

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